

# Low Cost 3.3 V Spread Aware Zero Delay Buffer

#### **Features**

- 10 MHz to 100 MHz and 133 MHz operating range, compatible with CPU and PCI bus frequencies
- Zero input-output propagation delay
- Multiple low skew outputs
  - □ Output-output skew less than 250 ps
  - □ Device-device skew less than 700 ps
  - □ One input drives five outputs (CY23S05)
  - □ One input drives nine outputs, grouped as 4 + 4 + 1 (CY23S09)
- Less than 200 ps Cycle-to-cycle jitter is compatible with Pentium based systems
- Test mode to bypass PLL (CY23S09 only, see Select Input Decoding for CY23S09 on page 2)
- Available in space saving 16-pin, 150-mil SOIC, 4.4 mm TSSOP (CY23S09) or 8-pin, 150-mil SOIC package (CY23S05)
- 3.3 V operation, advanced 0.65µ CMOS technology
- Spread Aware

#### **Functional Description**

The CY23S09 is a low cost 3.3 V zero delay buffer designed to distribute high speed clocks and is available in a 16-pin SOIC package. The CY23S05 is an 8-pin version of the CY23S09. It accepts one reference input, and drives out five low skew clocks. The -1H versions of each device operate at up to 100 and 133 MHz frequencies and have higher drive than the -1 devices.

All parts have on-chip PLLs that lock to an input clock on the REF pin. The PLL feedback is on-chip and is obtained from the CLKOUT pad.

The CY23S09 has two bans of four outputs each, which can be controlled by the select inputs as shown in the Select Input Decoding table on Select Input Decoding for CY23S09 on page 2. If all output clocks are not required, Bank B can be three-stated. The select inputs also allow the input clock to be directly applied to the outputs for chip and system testing purposes.

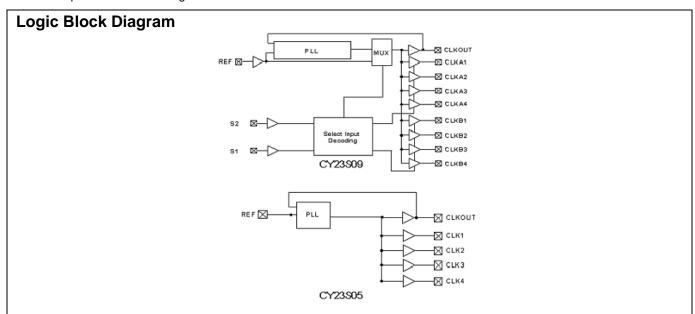
The CY23S09 and CY23S05 PLLs enter a power down mode when there are no rising edges on the REF input. In this state, the outputs are three-stated and the PLL is turned off, resulting in less than 12.0  $\mu$ A of current draw (for commercial temperature devices) and 25.0  $\mu$ A (for industrial temperature devices). The CY23S09 PLL shuts down in one additional case, as shown in the Select Input Decoding for CY23S09 on page 2.

Multiple CY23S09 and CY23S05 devices can accept the same input clock and distribute it. In this case, the skew between the outputs of two devices is guaranteed to be less than 700 ps.

All outputs have less than 200 ps of cycle-to-cycle jitter. The input to output propagation delay on both devices is guaranteed to be less than 350 ps; the output to output skew is guaranteed to be less than 250 ps.

The CY23S05 and CY23S09 is available in two different configurations, as shown in the Ordering Information on page 7. The CY23S05-1 and CY23S09-1 is the base part. The CY23S05-1H and CY23S09-1H is the high drive version of the -1, and its rise and fall times are much faster than -1.

For a complete list of related resources, click here.





#### Select Input Decoding for CY23S09

S2	S1	CLOCK A1-A4	CLOCK B1-B4	CLKOUT <sup>[1]</sup>	Output Source	PLL Shutdown
0	0	Three-state	Three-state	Driven	PLL	N
0	1	Driven	Three-state	Driven	PLL	N
1	0	Driven	Driven	Driven	Reference	Y
1	1	Driven	Driven	Driven	PLL	N

#### Zero Delay and Skew Control

All outputs must be uniformly loaded to achieve Zero Delay between the input and output. Because the CLKOUT pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay. This is shown in the above graph.

For applications requiring zero input-output delay, all outputs, including CLKOUT, must be equally loaded. Even if CLKOUT is not used, it must have a capacitive load equal to that on other outputs, to obtain zero input-output delay. If input to output delay adjustments are required, use the above graph to calculate loading differences between the CLKOUT pin and other outputs.

For zero output-output skew, be sure to load all outputs equally. For further information, see application note "AN1234 - CY2308: Zero Delay Buffer."

#### **Spread Aware**

Output Load Difference: CLKOUT Load - CLKA/CLKB Load (pF)

Many systems being designed now use a technology called Spread Spectrum Frequency Timing Generation. Cypress is one of the pioneers of SSFTG development and designed this product so as not to filter off the Spread Spectrum feature of the Reference input, assuming it exists. When a zero delay buffer is not designed to pass the SS feature through, the result is a significant amount of tracking skew, which may cause problems in systems requiring synchronization.

For more details on Spread Spectrum timing technology, please see the Cypress Whitepaper EMI and Spread Spectrum Technology.

#### Note

Document Number: 38-07296 Rev. \*H

<sup>1.</sup> This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and output.



#### **Pinouts**

Figure 2. Pin Configuration – CY23S09

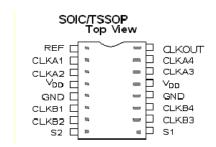


Figure 3. Pin Configuration - CY23S05

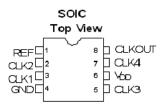


Table 1. Pin Description for CY23S09

Pin	Signal	Description
1	REF <sup>[2]</sup>	Input reference frequency, 5 V tolerant input
2	CLKA1 <sup>[3]</sup>	Buffered clock output, bank A
3	CLKA2 <sup>[3]</sup>	Buffered clock output, bank A
4	$V_{DD}$	3.3 V supply
5	GND	Ground
6	CLKB1 <sup>[3]</sup>	Buffered clock output, bank B
7	CLKB2 <sup>[3]</sup>	Buffered clock output, bank B
8	S2 <sup>[4]</sup>	Select input, bit 2
9	S1 <sup>[4]</sup>	Select input, bit 1
10	CLKB3 <sup>[3]</sup>	Buffered clock output, bank B
11	CLKB4 <sup>[3]</sup>	Buffered clock output, bank B
12	GND	Ground
13	$V_{DD}$	3.3 V supply
14	CLKA3 <sup>[3]</sup>	Buffered clock output, bank A
15	CLKA4 <sup>[3]</sup>	Buffered clock output, bank A
16	CLKOUT <sup>[3]</sup>	Buffered output, internal feedback on this pin

Table 2. Pin Description for CY23S05

Pin	Signal	Description
1	REF <sup>[2]</sup>	Input reference frequency, 5 V tolerant input
2	CLK2 <sup>[3]</sup>	Buffered clock output
3	CLK1 <sup>[3]</sup>	Buffered clock output
4	GND	Ground
5	CLK3 <sup>[3]</sup>	Buffered clock output
6	$V_{DD}$	3.3 V supply
7	CLK4 <sup>[3]</sup>	Buffered clock output
8	CLKOUT <sup>[3]</sup>	Buffered clock output, internal feedback on this pin

#### Notes

- Weak pull down.
   Weak pull down on all outputs.
   Weak pull up on these inputs.



## **Maximum Ratings**

Supply voltage to ground potential0.5 V to +7.0 V	Maximum soldering temperature (10 seconds) 260 °C
DC input voltage (Except REF)0.5 V to V <sub>DD</sub> + 0.5 V	Junction temperature 150 °C
DC input voltage REF0.5 V to 7 V	Static discharge voltage
Storage temperature65 °C to +150 °C	(per MIL-STD-883, Method 3015)> 2,000 V

## Operating Conditions for CY23S05SXX-XX and CY23S09SXX-XX Industrial, Commercial Devices<sup>[5]</sup>

Parameter	Description	Min	Max	Unit
$V_{DD}$	Supply voltage	3.0	3.6	V
T <sub>A</sub>	Operating temperature - Ambient (Commercial)	0	70	°C
	Operating temperature - Ambient (Industrial)	-40	85	°C
C <sub>L</sub>	Load capacitance, below 100 MHz		30	pF
C <sub>L</sub>	Load capacitance, from 100 MHz to 133 MHz		10	pF
C <sub>IN</sub>	Input capacitance		7	pF

# Electrical Characteristics for CY23S05SXC-XX and CY23S09SXC-XX Commercial Temperature Devices

Parameter	Description	Test Conditions	Min	Max	Unit
V <sub>IL</sub>	Input LOW voltage <sup>[6]</sup>			0.8	V
V <sub>IH</sub>	Input HIGH voltage <sup>[6]</sup>		2.0		V
I <sub>IL</sub>	Input LOW current	V <sub>IN</sub> = 0 V		50.0	μА
I <sub>IH</sub>	Input HIGH current	$V_{IN} = V_{DD}$		100.0	μА
V <sub>OL</sub>	Output LOW voltage <sup>[7]</sup>	I <sub>OL</sub> = 8 mA (-1) I <sub>OH =</sub> 12 mA (-1H)		0.4	V
V <sub>OH</sub>	Output HIGH voltage <sup>[7]</sup>	$I_{OH} = -8 \text{ mA } (-1)$ $I_{OL} = -12 \text{ mA } (-1\text{H})$	2.4		V
I <sub>DD</sub> (PD mode)	Power-down supply current	REF = 0 MHz		12.0	μА
I <sub>DD</sub>	Supply current	Unloaded outputs at 66.67 MHz, SEL inputs at V <sub>DD</sub>		32.0	mA

# Switching Characteristics for CY23S05SXC-1 and CY23S09SXC-1 Commercial Temperature Devices [8]

	<u> </u>					
Parameter	Description	Test Conditions	Min	Тур	Max	Unit
t1	Output frequency	30 pF load 10 pF load	10 10		100 133.33	MHz MHz
	Duty cycle <sup>[7]</sup> = $t_2 \div t_1$	Measured at 1.4 V, F <sub>out</sub> = 66.67 MHz	40.0	50.0	60.0	%
t3	Rise time <sup>[7]</sup>	Measured between 0.8 V and 2.0 V			2.50	ns
t <sub>4</sub>	Fall time <sup>[7]</sup>	Measured between 0.8 V and 2.0 V			2.50	ns
t <sub>5</sub>	Output-to-output skew <sup>[7]</sup>	All outputs equally loaded			250	ps
t <sub>6</sub>	Delay, REF Rising Edge to CLKOUT Rising Edge <sup>[7]</sup>	Measured at V <sub>DD</sub> /2		0	±350	ps
t <sub>7</sub>	Device-to-device skew <sup>[7]</sup>	Measured at V <sub>DD</sub> /2 on the CLKOUT pins		0	700	ps
t <sub>J</sub>	Cycle-to-cycle jitter[7]	Measured at 66.67 MHz, loaded outputs			200	ps
t <sub>LOCK</sub>	PLL lock time <sup>[7]</sup>	Stable power supply, valid clock presented on REF pin			1.0	ms

- 5. Multiple Supplies: The voltage on any input or I/O pin cannot exceed the power pin during power up. Power supply sequencing is NOT required.
- 6. REF input has a threshold voltage of V<sub>DD</sub>/2.
  7. Parameter is guaranteed by design and characterization. Not 100% tested in production.
- 8. All parameters specified with loaded outputs.



# Switching Characteristics for CY23S05SXI-1H Industrial Temperature Devices<sup>[8]</sup>

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
t1	Output frequency	30 pF load 10 pF load	10 10		100 133.33	MHz MHz
	Duty cycle <sup>[7]</sup> = $t_2 \div t_1$	Measured at 1.4 V, F <sub>out</sub> = 66.67 MHz	40.0	50.0	60.0	%
	Duty cycle <sup>[7]</sup> = $t_2 \div t_1$	Measured at 1.4 V, F <sub>out</sub> <50.0 MHz	45.0	50.0	55.0	%
t3	Rise time <sup>[7]</sup>	Measured between 0.8 V and 2.0 V			1.50	ns
t <sub>4</sub>	Fall time <sup>[7]</sup>	Measured between 0.8 V and 2.0 V			1.50	ns
t <sub>5</sub>	Output-to-output skew <sup>[7]</sup>	All outputs equally loaded			250	ps
t <sub>6</sub>	Delay, REF Rising Edge to CLKOUT Rising Edge <sup>[7]</sup>	Measured at V <sub>DD</sub> /2		0	±350	ps
t <sub>7</sub>	Device-to-Device Skew <sup>[7]</sup>	Measured at V <sub>DD</sub> /2 on the CLKOUT pins of devices		0	700	ps
t <sub>8</sub>	Output slew rate <sup>[7]</sup>	Measured between 0.8 V and 2.0 V using Test Circuit #2	1			V/ns
tj	Cycle-to-cycle jitter <sup>[7]</sup>	Measured at 66.67 MHz, loaded outputs			200	ps
t <sub>LOCK</sub>	PLL lock time <sup>[7]</sup>	Stable power supply, valid clock presented on REF pin			1.0	ms

# **Switching Waveforms**

Figure 4. Duty Cycle Timing

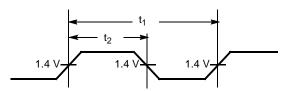


Figure 5. All Outputs Rise/Fall Time

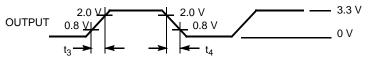


Figure 6. Output-Output Skew

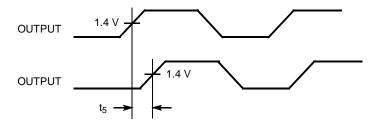
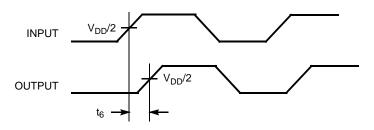


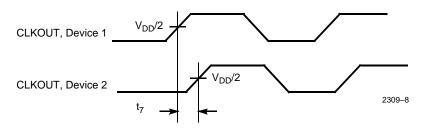
Figure 7. Input-Output Propagation Delay



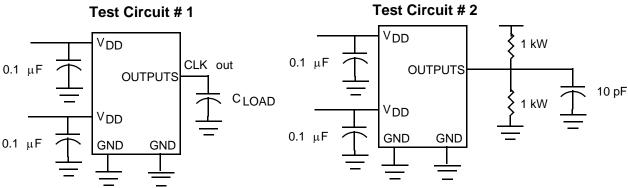


# Switching Waveforms continued

Figure 8. Device-Device Skew



## **Test Circuits**



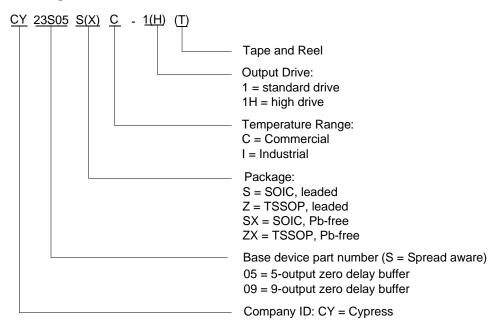
For parameter t8 (output slew rate) on -1H devices



# **Ordering Information**

Ordering Code	Package Name	Package Type	Operating Range
Pb-Free			
CY23S05SXC-1	SZ08	8-pin 150-mil SOIC	Commercial (0 ° to 70 °C)
CY23S05SXC-1T	SZ08	8-pin 150-mil SOIC – Tape and Reel	Commercial (0 ° to 70 °C)
CY23S05SXC-1H	SZ08	8-pin 150-mil SOIC	Commercial (0 ° to 70 °C)
CY23S05SXC-1HT	SZ08	8-pin 150-mil SOIC – Tape and Reel	Commercial (0 ° to 70 °C)
CY23S05SXI-1	SZ08	8-pin 150-mil SOIC	Industrial (-40 ° to 85 °C)
CY23S05SXI-1T	SZ08	8-pin 150-mil SOIC – Tape and Reel	Industrial (–40 ° to 85 °C)
CY23S09SXC-1	SZ16	16-pin 150-mil SOIC	Commercial (0 ° to 70 °C)
CY23S09SXC-1T	SZ16	16-pin 150-mil SOIC – Tape and Reel	Commercial (0 ° to 70 °C)
CY23S09SXC-1H	SZ16	16-pin 150-mil SOIC	Commercial (0 ° to 70 °C)
CY23S09SXC-HT	SZ16	16-pin 150-mil SOIC – Tape and Reel	Commercial (0 ° to 70 °C)
CY23S09ZXC-1H	ZZ16	16-pin 4.4 mm TSSOP	Commercial (0 ° to 70 °C)
CY23S09ZXC-1HT	ZZ16	16-pin 4.4 mm TSSOP – Tape and Reel	Commercial (0 ° to 70 °C)

#### **Ordering Code Definitions**





## **Package Diagrams**

Figure 9. 8-Pin (150-Mil) SOIC S08 and SZ08

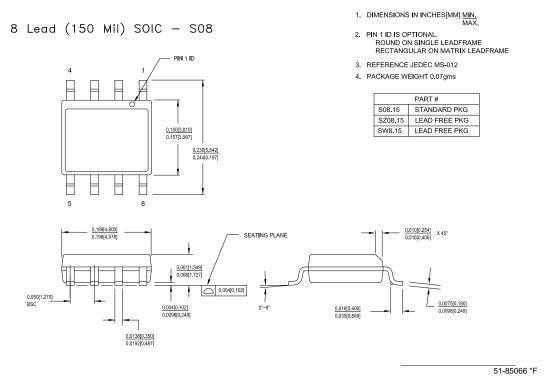
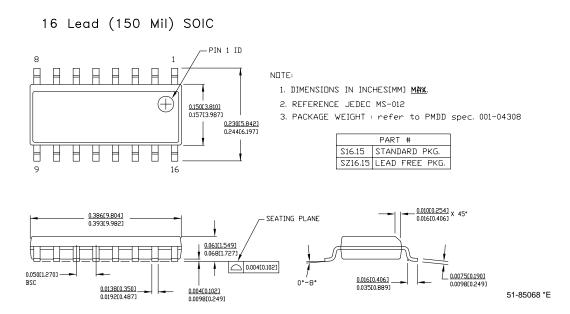


Figure 10. 16-Pin (150-Mil) SOIC S16 and SZ16

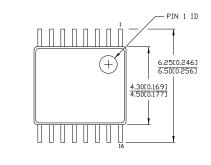




# Package Diagrams continued

Figure 11. 16-Pin TSSOP 4.40 mm Body Z16 and ZZ16

16 Lead TSSOP 4.40 MM BODY

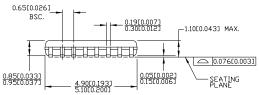


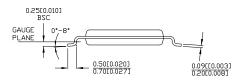
DIMENSIONS IN MMCINCHES) MIN. MAX.

REFERENCE JEDEC MO-153

PACKAGE WEIGHT 0.05gms

PART #				
Z16.173	STANDARD PKG.			
ZZ16.173	LEAD FREE PKG.			





51-85091 \*E



# Acronym

Acronym	Description
CMOS	complementary metal oxide semiconductor
EMI	electromagnetic interference
PLL	phase-locked loop
SOIC	small outline integrated circuit
SS	spread spectrum
SSFTG	spread spectrum frequency timing generator
SSOP	shrunk small outline package
TSSOP	thin shrunk small outline package

## **Document Conventions**

#### **Units of Measure**

Symbol	Unit of Measure
°C	degree Celsius
MHZ	megahertz
uA	microamperes
mA	milliamperes
ms	milliseconds
ns	nanoseconds
%	percent
pF	picofarads
ps	picoseconds
V	volt



# **Document History Page**

Rev.	ECN No.	Submission Date	Orig. of Change	Description of Change
**	111147	11/14/01	DSG	Changed from spec number 38-01094 to 38-07296
*A	111773	02/20/02	CTK	Added 150-mil SSOP option
*B	122885	12/22/02	RBI	Added power-up requirements to Operating Conditions
*C	267849	See ECN	RGL	Added Lead-Free devices
*D	2595524	10/23/08	CXQ/PYRS	Added device "Status" to Ordering Information
*E	2761988	09/10/09	KVM	Removed obsolete parts from Ordering Information table: CY23S09ZC-1, CY23S09OC-1, CY23S09OC-1H, CY23S09ZXC-1, CY23S09OXC-1H, CY23S09DXC-1H, CY23S09DXC-1H, CY23S09SXC-1H, CY23S09SXC-1HT, CY23S09SXC-1HT, CY23S09SXC-1HT, CY23S09ZXC-1HT.  Removed Status column from Ordering Information table; added footnote Updated package names and added numerical temperature range to Ordering Information table.  Removed QSOP package drawing.
*F	2897373	03/22/10	CXQ	Removed part numbers CY23S05SC-1, CY23S05SC-1H, CY23S09SC-1 CY23S09SC-1H, and CY23S09ZC-1H from Ordering Information table. Added CY23S05SXI-1 and CY23S05SXI-1T to Ordering Information table Updated package diagrams. Updated copyright section.
*G	3394655	10/04/11	PURU	Added Figure 1 Updated Hyper links Updated Package Diagrams Added Ordering Code Definitions, Acronym, and Units of Measure.
*H	4564025	11/07/2014	TAVA	Removed the SSOP package in Features. Updated Figure 2 (removed SSOP). Updated Figure 7. Replaced all occurrences of SC and SI with SXC and SXI in the following tables: Operating Conditions for CY23S05SXX-XX and CY23S09SXX-XX Industrial, Commercial Devices <sup>[5]</sup>
				Electrical Characteristics for CY23S05SXC-XX and CY23S09SXC-XX Commercial Temperature Devices  Switching Characteristics for CY23S05SXC-1 and CY23S09SXC-1 Commercial Temperature Devices [8]  Switching Characteristics for CY23S05SXI-1H Industrial Temperature
				Updated the table, Operating Conditions for CY23S05SXX-XX and CY23S09SXX-XX Industrial, Commercial Devices <sup>[5]</sup> .  Removed CY23S09SI-1H in the table title, in Switching Characteristics for CY23S05SXI-1H Industrial Temperature Devices <sup>[8]</sup> .  Updated Figure 9, Figure 10, and Figure 11 in Package Diagrams.



#### Sales, Solutions, and Legal Information

#### Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

#### **Products**

Automotive cypress.com/go/automotive Clocks & Buffers cypress.com/go/clocks Interface cypress.com/go/interface Lighting & Power Control cypress.com/go/powerpsoc

cypress.com/go/plc
Memory cypress.com/go/memory
Optical & Image Sensing cypress.com/go/image
PSoC cypress.com/go/psoc
Touch Sensing cypress.com/go/touch
USB Controllers cypress.com/go/USB
Wireless/RF cypress.com/go/wireless

#### **PSoC Solutions**

psoc.cypress.com/solutions PSoC 1 | PSoC 3 | PSoC 5

© Cypress Semiconductor Corporation, 2001-2014. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Any Source Code (software and/or firmware) is owned by Cypress Semiconductor Corporation (Cypress) and is protected by and subject to worldwide patent protection (United States and foreign), United States copyright laws and international treaty provisions. Cypress hereby grants to licensee a personal, non-exclusive, non-transferable license to copy, use, modify, create derivative works of, and compile the Cypress Source Code and derivative works for the sole purpose of creating custom software and or firmware in support of licensee product to be used only in conjunction with a Cypress integrated circuit as specified in the applicable agreement. Any reproduction, modification, translation, compilation, or representation of this Source Code except as specified above is prohibited without the express written permission of Cypress.

Disclaimer: CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Cypress reserves the right to make changes without further notice to the materials described herein. Cypress does not assume any liability arising out of the application or use of any product or circuit described herein. Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress' product in a life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Use may be limited by and subject to the applicable Cypress software license agreement.